PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE: NEW ASSIGNMENT

NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Detlef Haje	09/30/2009

RECEIVING PARTY DATA

Name:	Siemens Aktiengesellschaft	
Street Address:	Wittelsbacherplatz 2	
City:	Muenchen	
State/Country:	GERMANY	
Postal Code:	80333	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12553236

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: 2008P13099US

NAME OF SUBMITTER: YE REN

Total Attachments: 2

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> PATENT REEL: 023480 FRAME: 0531

CH \$40.00 125

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ASSIGNMENT

For good and valuable consideration, I/we, the undersigned

Dr. Detlef Haje

residing at:

residing at:

Heilige-Grab-Str. 77 02828 Görlitz GERMANY

residing at:

residing at:

residing at:

residing at:

residing at:

residing at:

hereby sell, assign, and transfer to

Siemens Aktiengesellschaft

a German corporation

organized and existing under the laws of GERMANY

having its (their) principal place of business

in München; GERMANY

herein the "Assignee(s)", its (their) successor(s), assigns and legal representatives the entire and exclusive right, title and interest in and for the United States, in all and to any improvements in the

(Title:) APPARATUS AND METHOD FOR REDUCING THE PRESSURE ON A JOINT BETWEEN AT LEAST TWO DELIMITING PARTS

disclosed in the application for Letters Patent designating the United States, said application being identified in our records as

Applicants File No.

2008P13099 US

Serial No.

12/553,236

Application Date

03.Sept. 2009

IDNR: 2589 / 22.06.2007

PATENT REEL: 023480 FRAME: 0532 and in and to said application and all divisional, continuing substitute, renewal, reissue and all other applications for Letters Patent which have been or shall be filed in the United States on any of said improvements; and in and to all original and reissued patents which have been or shall be issued in the United States on said improvements;

hereby agree that said Assignee(s) may apply for and receive Letters Patent for said improvements in its (their) own name and that when requested without charge to but at the expense of said Assignee(s), its (their) successor(s), assigns, and legal representatives, to carry out in good faith the intent and purpose of this agreement, the undersigned will execute all divisional, continuing substitute, renewal, reissue and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee(s), its (their) successor(s), assigns and legal representatives all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee(s), its (their) successor(s), assigns, or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements in said Assignee(s), its (their) successor(s), assigns, and legal representatives; and

hereby covenant with said Assignee(s), its (their) successor(s), assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed had been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date: 2009-09-30

RECORDED: 11/06/2009

Witnesses: Judy 121 ell

(printed name: Beate Schwidt

Dr. Detlef Haie

Witnesses:

(printed name: ___OLIV

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REEL: 023480 FRAME: 0533